

### 60V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

## **Product Summary**

BV <sub>DSS</sub>	Rds(on)	I <sub>D</sub> Tc = +25°C	
60V	16mΩ @ V <sub>GS</sub> = 10V	37.1A	
60 V	24mΩ @ V <sub>GS</sub> = 4.5V	30.3A	

## **Description and Applications**

This MOSFET has been designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Power Management
- DC-DC Converters
- Motor Control

### **Features**

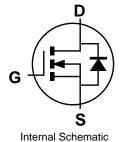
- Rated to +175°C Ideal for High Ambient Temperature Environments
- Thermally Efficient Package Cooler Running Applications
- High Conversion Efficiency
- Low R<sub>DS(ON)</sub> Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- <1.1mm Package Profile Ideal for Thin Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH6016LPSQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

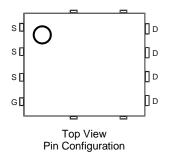
https://www.diodes.com/quality/product-definitions/

### **Mechanical Data**

- Case: PowerDI<sup>®</sup>5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)







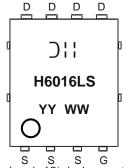
## **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMTH6016LPSQ-13	PowerDI5060-8	2,500 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



☐ He Manufacturer's Marking
H6016LS = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 21 = 2021)
WW = Week Code (01 to 53)

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DMTH6016LPSQ

Document number: DS38518 Rev. 3 - 2

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# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			VDSS	60	V
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
Continuous Drain Current (Note 6) $V_{GS} = 10V$ $T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$			lo	37.1 26.2	А
Continuous Drain Current (Note 5) Vcs = 10V		T <sub>A</sub> = +25°C T <sub>A</sub> = +100°C	lo	10.6 7.5	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	145	Α	
Maximum Continuous Body Diode Forward Current (Note 6)			Is	31	Α
Avalanche Current, L = 0.1mH			I <sub>AS</sub>	15.3	Α
Avalanche Energy, L = 0.1mH			Eas	11.7	mJ

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	3	W
Thermal Resistance, Junction to Ambient (Note 5)  Steady State		Reja	49	°C/W
Total Power Dissipation (Note 6) $T_C = +25^{\circ}C$		PD	37.5	W
Thermal Resistance, Junction to Case (Note 6)	Rejc	4	°C/W	
Operating and Storage Temperature Range		$T_{J,}T_{STG}$	-55 to +175	°C

# Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

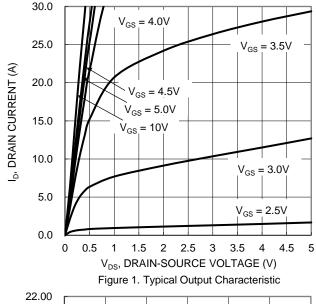
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	60	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μA	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(th)	1	_	2.5	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	D	_	12.4	16	mΩ	V <sub>G</sub> S = 10V, I <sub>D</sub> = 20A	
Static Drain-Source On-Resistance	RDS(ON)	_	18.2	24	11177	$V_{GS} = 4.5V, I_D = 18A$	
Diode Forward Voltage	$V_{SD}$	_	0.7	1.2	V	V <sub>G</sub> S = 0V, I <sub>S</sub> = 1A	
DYNAMIC CHARACTERISTICS (Note 8)	•						
Input Capacitance	Ciss	_	864	_		\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
Output Capacitance	Coss	_	282	_	pF	$V_{DS} = 30V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Reverse Transfer Capacitance	Crss	_	27	_		1 – 11011 12	
Gate Resistance	Rg	_	1.3	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	8.4	_			
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	17	_	nC	\/ 20\/ I- 40A	
Gate-Source Charge	Qgs	_	3.1	_	nc	$V_{DS} = 30V, I_{D} = 10A$	
Gate-Drain Charge	$Q_{gd}$	_	4.3	_			
Turn-On Delay Time	tD(ON)	_	3.4	_			
Turn-On Rise Time	tR	_	5.2	_		$V_{GS} = 10V, V_{DS} = 30V,$ $R_{G} = 6\Omega, I_{D} = 10A$	
Turn-Off Delay Time	tD(OFF)	_	13	_	ns		
Turn-Off Fall Time	tF		7	_			
Reverse Recovery Time	t <sub>RR</sub>	_	22	_	ns	1 404 31/31 4004/	
Reverse Recovery Charge	Qrr	_	11	_	nC	$I_F = 10A$ , $di/dt = 100A/\mu s$	

5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad). 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.







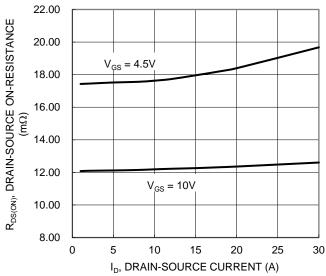


Figure 3. Typical On-Resistance vs Drain Current and Gate Voltage

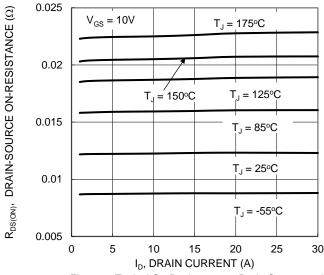
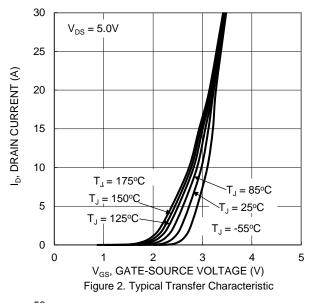


Figure 5. Typical On-Resistance vs Drain Current and Temperature



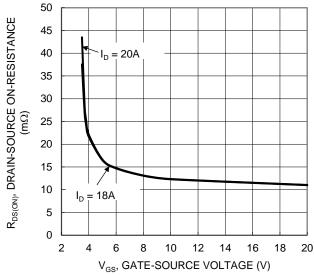


Figure 4. Typical Transfer Characteristic

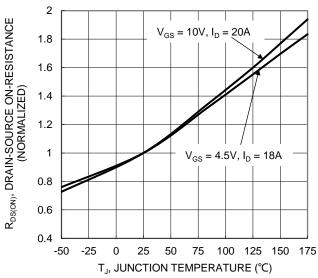
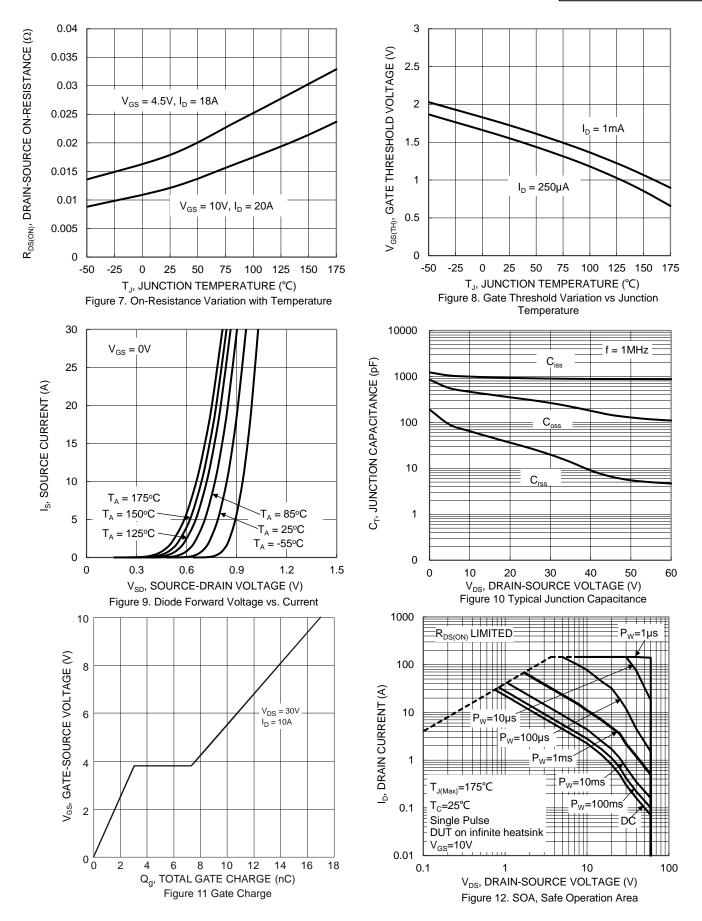


Figure 6. On-Resistance Variation with Temperature







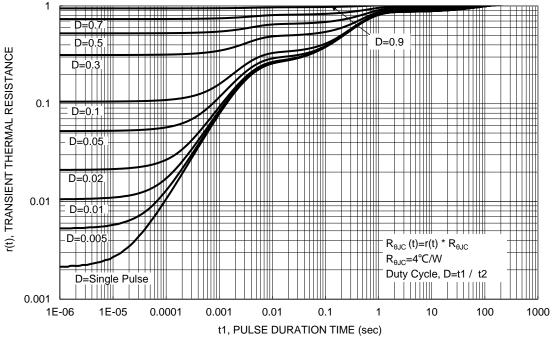


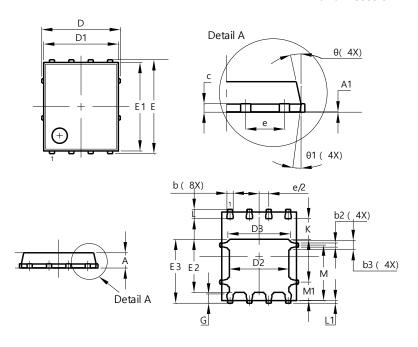
Figure 13. Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI5060-8

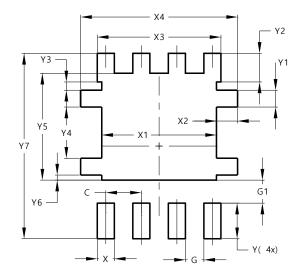


PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
<b>A</b> 1	0.00 0.05 -				
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D		5.15 BSC			
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90 4.30 4.10				
E	6.15 BSC				
E1	5.60 6.00		5.80		
E2	3.28	3.68	3.48		
E3	3.99 4.39 4.19				
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51 – –				
L	0.51	0.71	0.61		
L1	0.100 0.200 0.17				
M	3.235 4.035 3.6				
M1	1.00 1.40 1.21				
Θ	10°	12º	11º		
Θ1	6º	8º	7º		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Υ	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610



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